

74HC05-Q100

Hex inverter with open-drain outputs

Rev. 2 — 8 July 2020

Product data sheet

1. General description

The 74HC05-Q100 contains six inverters. The outputs of the 74HC05-Q100 are open-drain and can be connected to other open-drain outputs to implement active-LOW wired-OR or active-HIGH wired-AND functions. The open-drain outputs require pull-up resistors to perform correctly.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide operating voltage 2.0 V to 6.0 V
- CMOS input levels
- Latch-up performance exceeds 100 mA per JESD 78 Class II level A
- Complies with JEDEC standard no. 7A
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

3. Ordering information

Table 1. Ordering information

| Type number | Package | | | |
|---------------|-------------------|----------|--|----------|
| | Temperature range | Name | Description | Version |
| 74HC05D-Q100 | -40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| 74HC05PW-Q100 | -40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |
| 74HC05BQ-Q100 | -40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm | SOT762-1 |

4. Functional diagram

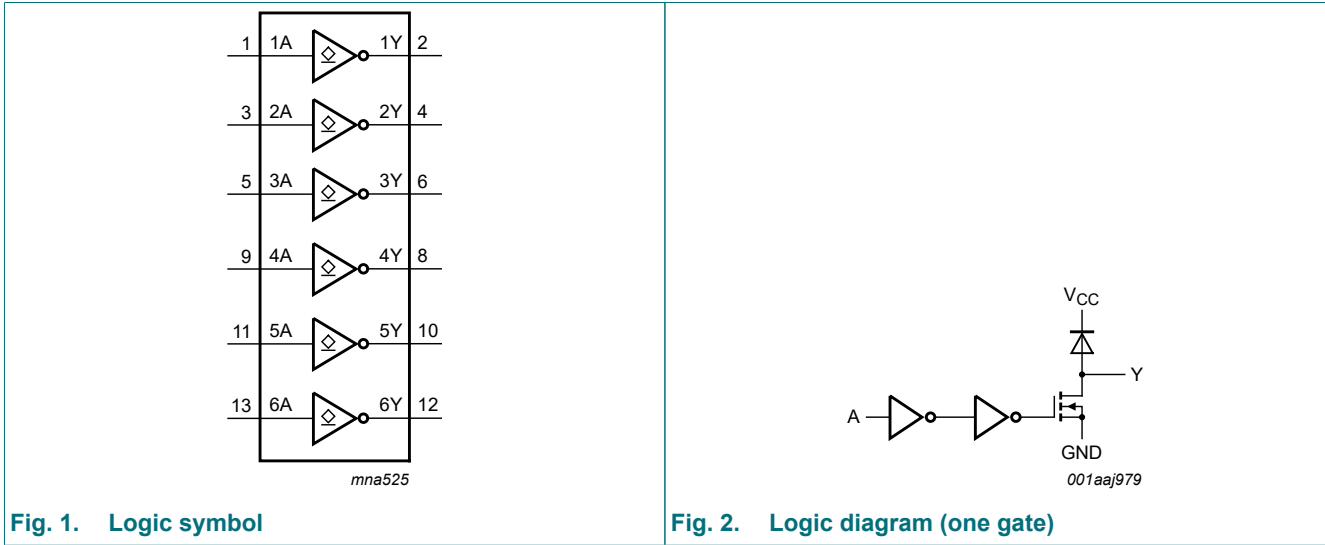


Fig. 1. Logic symbol

Fig. 2. Logic diagram (one gate)

5. Pinning information

5.1. Pinning

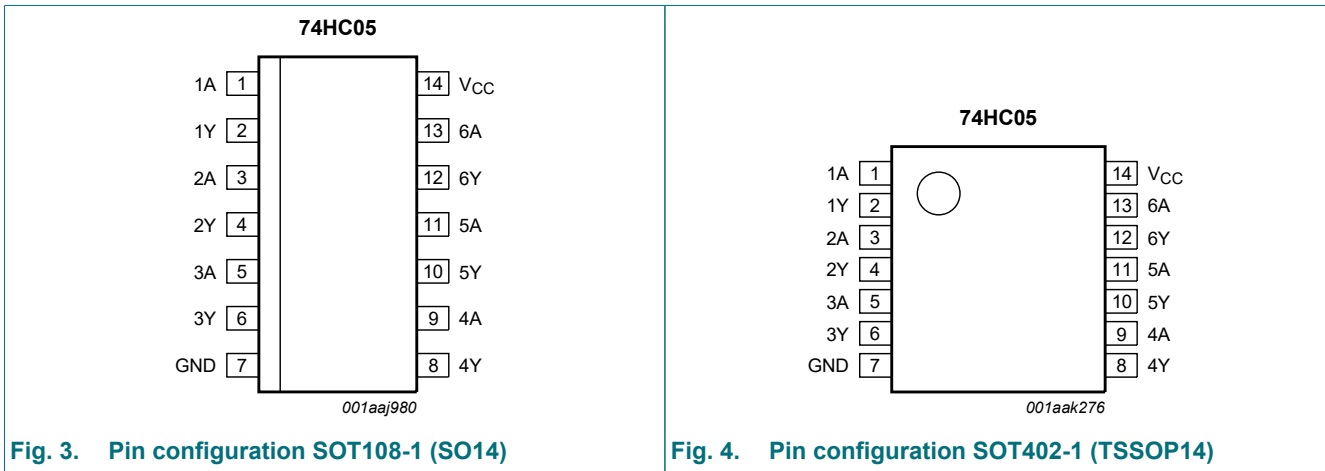
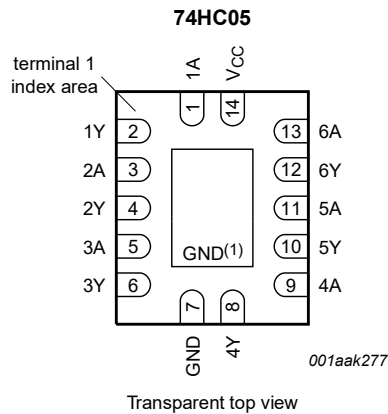


Fig. 3. Pin configuration SOT108-1 (SO14)

Fig. 4. Pin configuration SOT402-1 (TSSOP14)



(1) This is not a ground pin. There is no electrical or mechanical requirement to solder the pad. In case soldered, the solder land should remain floating or connected to GND.

Fig. 5. Pin configuration SOT762-1 (DHVQFN14)

5.2. Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|--------------------|----------------|
| 1A to 6A | 1, 3, 5, 9, 11, 13 | data input |
| 1Y to 6Y | 2, 4, 6, 8, 10, 12 | data output |
| GND | 7 | ground (0 V) |
| V _{CC} | 14 | supply voltage |

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

| Input | Output |
|-------|--------|
| nA | nY |
| L | Z |
| H | L |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|--|------|-------------------------|------|
| V_{CC} | supply voltage | | -0.5 | +7 | V |
| I_{IK} | input clamping current | $V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$ [1] | - | ± 20 | mA |
| I_{OK} | output clamping current | $V_O < -0.5\text{ V}$ or $V_O > V_{CC} + 0.5\text{ V}$ [1] | - | ± 20 | mA |
| V_O | output voltage | [1] | -0.5 | $V_{CC} + 0.5\text{ V}$ | V |
| I_O | output current | $V_O < V_{CC} + 0.5\text{ V}$ | - | 25 | mA |
| I_{CC} | supply current | | - | 50 | mA |
| I_{GND} | ground current | | -50 | - | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | [2] | - | 500 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C.

For SOT402-1 (TSSOP14) package: P_{tot} derates linearly with 7.3 mW/K above 81 °C.

For SOT762-1 (DHVQFN14) package: P_{tot} derates linearly with 9.6 mW/K above 98 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------|-------------------------------------|-------------------------|-----|------|----------|------|
| V_{CC} | supply voltage | | 2.0 | 5.0 | 6.0 | V |
| V_I | input voltage | | 0 | - | V_{CC} | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| T_{amb} | ambient temperature | | -40 | - | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 2.0\text{ V}$ | - | - | 625 | ns/V |
| | | $V_{CC} = 4.5\text{ V}$ | - | 1.67 | 139 | ns/V |
| | | $V_{CC} = 6.0\text{ V}$ | - | - | 83 | ns/V |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|-----------------|--------------------------|---|-------|------|------|------------------|------|-------------------|------|------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.5 | 1.2 | - | 1.5 | - | 1.5 | - | V |
| | | V _{CC} = 4.5 V | 3.15 | 2.4 | - | 3.15 | - | 3.15 | - | V |
| | | V _{CC} = 6.0 V | 4.2 | 3.2 | - | 4.2 | - | 4.2 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | 0.8 | 0.5 | - | 0.5 | - | 0.5 | V |
| | | V _{CC} = 4.5 V | - | 2.1 | 1.35 | - | 1.35 | - | 1.35 | V |
| | | V _{CC} = 6.0 V | - | 2.8 | 1.8 | - | 1.8 | - | 1.8 | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | | | | | |
| | | I _O = 20 μA; V _{CC} = 2.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 4.5 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 6.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 4.0 mA; V _{CC} = 4.5 V | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| | | I _O = 5.2 mA; V _{CC} = 6.0 V | - | 0.16 | 0.26 | - | 0.33 | - | 0.4 | V |
| I _I | input leakage current | V _I = V _{CC} or GND; V _{CC} = 6.0 V | - | - | ±0.1 | - | ±1 | - | ±1 | μA |
| I _{OZ} | OFF-state output current | V _I = V _{IL} ; V _O = V _{CC} or GND; V _{CC} = 6.0 V | - | - | ±0.5 | - | ±5.0 | - | ±10 | μA |
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 6.0 V | - | - | 2.0 | - | 20 | - | 40 | μA |
| C _I | input capacitance | | - | 3.5 | - | - | - | - | - | pF |

10. Dynamic characteristics

Table 7. Dynamic characteristics

$GND = 0\text{ V}$; for test circuit see [Fig. 7](#).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +125 °C | | Unit | |
|------------------|------------------------------------|---|-------|-----|-----|-------------------|--------------|------|----|
| | | | Min | Typ | Max | Max (85 °C) | Max (125 °C) | | |
| t _{PLZ} | LOW to OFF-state propagation delay | nA to nY; see Fig. 6 | | | | | | | |
| | | V _{CC} = 2.0 V | - | 20 | 90 | 115 | 135 | ns | |
| | | V _{CC} = 4.5 V | - | 11 | 18 | 23 | 27 | ns | |
| t _{PZL} | OFF-state to LOW propagation delay | nA to nY; see Fig. 6 | | | | | | | |
| | | V _{CC} = 2.0 V | - | 22 | 90 | 115 | 135 | ns | |
| | | V _{CC} = 4.5 V | - | 9 | 18 | 23 | 27 | ns | |
| t _{THL} | HIGH to LOW output transition time | see Fig. 6 | | | | | | | |
| | | V _{CC} = 2.0 V | - | 18 | 75 | 95 | 110 | ns | |
| | | V _{CC} = 4.5 V | - | 6 | 15 | 19 | 22 | ns | |
| C _{PD} | power dissipation capacitance | per inverter; V _I = GND to V _{CC} ; V _{CC} = 5.0 V | [1] | - | 4 | - | - | - | pF |

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(0.5 \times C_L \times V_O^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

V_O = output voltage in V (output HIGH);

V_{CC} = supply voltage in V;

N = number of inputs switching;

R_L = load resistance in MΩ;

C_L = load capacitance in pF;

10.1. Waveforms and test circuit

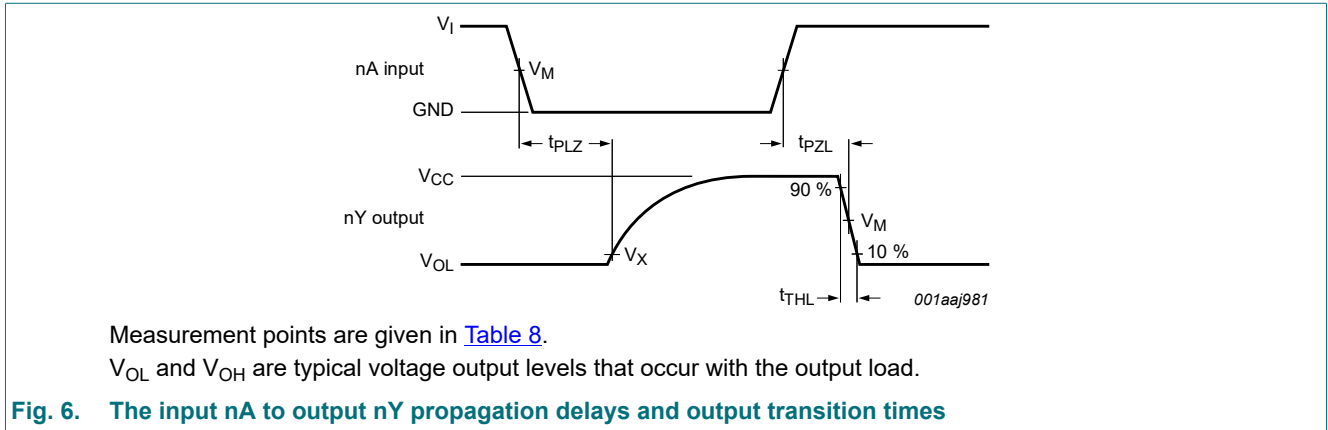


Table 8. Measurement points

| Input | Output | |
|-------------|-------------|-------------|
| V_M | V_M | V_x |
| $0.5V_{CC}$ | $0.5V_{CC}$ | $0.1V_{CC}$ |

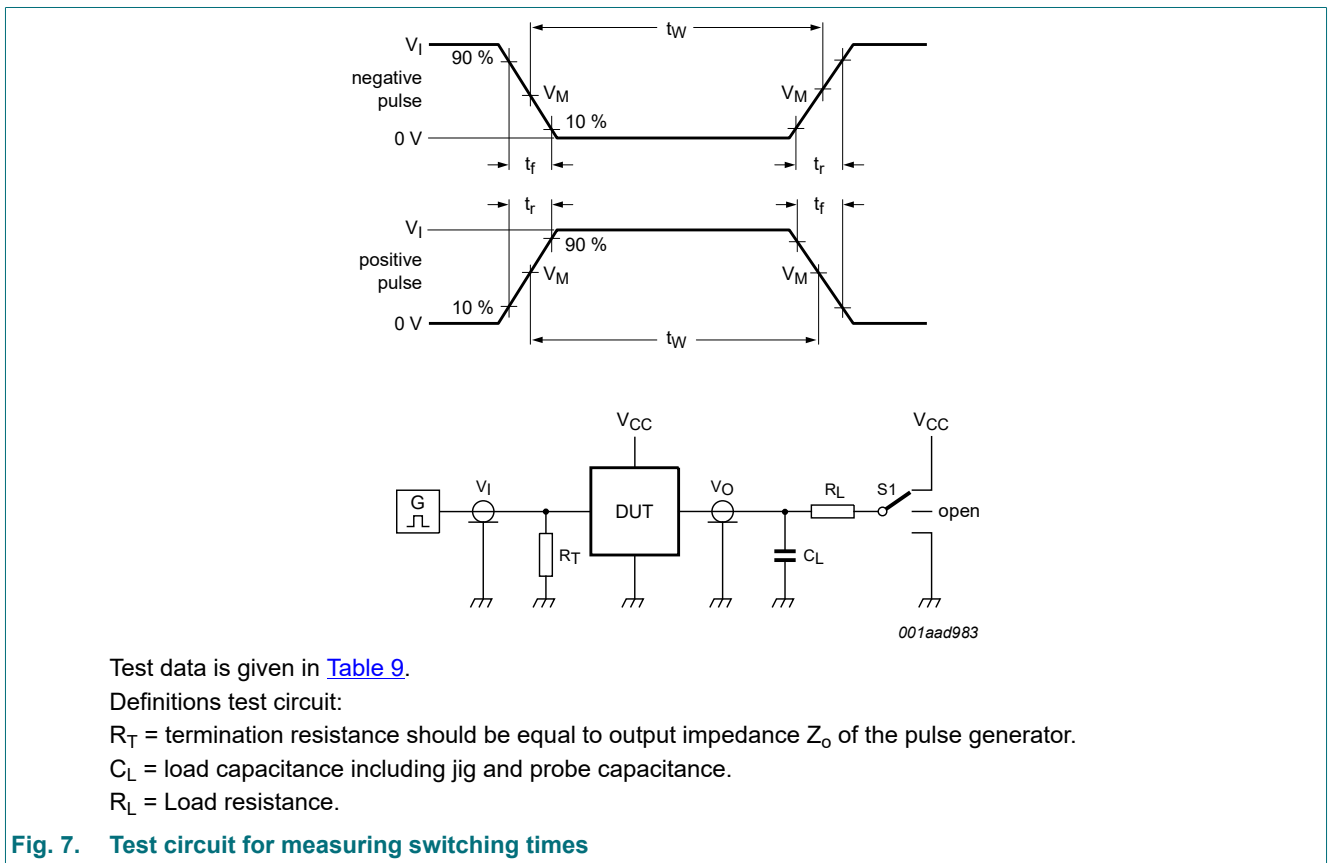


Table 9. Test data

| Input | | Load | | S1 position |
|----------|------------|-------|-------|--------------------|
| V_I | t_r, t_f | C_L | R_L | t_{PZL}, t_{PLZ} |
| V_{CC} | 6 ns | 50 pF | 1 kΩ | V_{CC} |

11. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



Fig. 8. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



Fig. 9. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1



Fig. 10. Package outline SOT762-1 (DHVQFN14)

12. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MIL | Military |
| MM | Machine Model |

13. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-----------------|---|--------------------|---------------|-----------------|
| 74HC05_Q100 v.2 | 20200708 | Product data sheet | - | 74HC05_Q100 v.1 |
| Modifications: | <ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Section 1 and Section 2 updated. Table 4: Derating values for P_{tot} total power dissipation have been updated. Table 6: Conditions for I_{OZ} corrected. Package outline drawing of SOT762-1 (Fig. 10) updated. | | | |
| 74HC05_Q100 v.1 | 20120709 | Product data sheet | - | - |

14. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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- [2] The term 'short data sheet' is explained in section "Definitions".
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